

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Gary Shueng Han CHAN	03/14/2007
Vanessa Meng I LEI	03/16/2007
Patrick Chun Sing FAN	03/21/2007
Marvin Yuk Kit KWOK	03/20/2007
Reeve Kit Wah LAU	03/20/2007
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PROPERTY NUMBERS Total: 1	
Property Type	Number
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**PATENT
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Total Attachments: 6

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ASSIGNMENT

As a below-named inventor of the U.S. patent application entitled **An Efficient Person Search Mechanism in Peer-to-Peer Networks**, which names an inventorship of **Gary Shueng Han CHAN, Vanessa Meng I LEI, Patrick Chun Sing FAN, Marvin Yuk Kit KWOK, Reeve Kit Wah LAU, and Ivan Ka Wai LEE**, and which was filed 11/21/06 and received Serial No.

11/562,103, I hereby sell, assign and transfer to **The Hong Kong University of Science and Technology, Clear Water Bay, Kowloon, Hong Kong**, (hereinafter referred to as ASSIGNEE), for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the full and exclusive right, title and interest to said invention in the United States and its territorial possessions and in all foreign countries and to all Letters Patent or similar legal protection in the United States and its territorial possessions and in all foreign countries to be obtained for said invention by said application or any division, continuation, continuation-in-part, renewal, substitute, extension, re-examination or reissue thereof or any legal equivalent thereof in the United States or any foreign country for the full term or terms of which the same may be granted, and specifically including the right to file foreign applications and claim priority therefore under the provisions of any convention or treaty;

and I also hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;

and I further hereby covenant that I will, upon ASSIGNEE'S request, promptly provide ASSIGNEE with all pertinent facts and documents, relating to said application, to any invention disclosed therein, or to any of said Letters Patent or legal equivalents thereof in the United States or in foreign countries, as may be known and accessible to me, and that I will testify and give evidence as to the same in any litigation or interference which may arise, and that I will promptly execute and deliver to ASSIGNEE or its legal representative, without charge but at Assignee's expense, any and all papers, instruments or affidavits which may be required, necessary or desirable for the purpose of applying for, obtaining, maintaining, issuing or enforcing said application and said Letters Patent and said equivalents thereof in the United States or in any foreign country; and I further authorize ASSIGNEE or its legal representative to make any submissions or true declarations which may be needed in connection with the prosecution of this application or related applications in the U.S. or in other countries, consistent with the requirements of the applicable country;

AND I HEREBY AUTHORIZE AND REQUEST the issuing authority

to issue any and all United States and foreign patents granted on said invention to ASSIGNEE, its successors and assigns.

IN WITNESS WHEREOF, this Assignment has been executed on the date set forth below.

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Date: 14 March 07 Signature: [Signature]

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